DECLARATION AND PO...R OF ATTORNEY FOR PATEN. APPLICATION DOCKET NO ISS8-518

As a below named Inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled A Ker-Hole Free Process For High Aspect Ratio Cap Filling With Reentrant Spacer

the specification of which (check one)

X is attached hereto			
was filed on	-11-99		
Application Serial No	09/247,974		
and was amended on			
I hereby state that I have reviewed amended by any amendment refer	(if applicable) I and understand the contents of the contents	he above Identified specification inclu	ding the claims, as
I acknowledge the duty to disclose 37, Code of Federal Regulations,	e information which is material to \$1.56(a).	the examination of this application in a	accordance with Title
I hereby claim foreign priority ben inventor's certificate listed below a filing date before that of the appl Prior Foreign Application(s)	efits under Title 35, United State and have also identified below an lication on which priority is claim	B Code §119 of any foreign application y foreign application for patent or inver ed:	(s) for patent or ntor's certificate havin
		Priority	Claimed:
(Number)	(Country)	(Day/Month/Year Filed)	•
(Number)	(Country)	(Day/Month/Your Filed)	•
	tle 35, United States Code §120 of claims of this application is not of file 35, United States Code, §17 ll Regulations, §1.56(a) which oc date of this application:	of any United States application(s) liste lisclosed in the prior United States app 2, I acknowledge the duty to disclose r curred between the filing date of the pr	d below and, insofar lication in the manner naterial information a ior application and th
(Application Serial No.)	(Filing Date) (Sta	tus) (patented, pending, abandoned)	
I hereby declare that all statements belief are believed to be true; and fi the like so made are punishable by that such willful false statements ma	made herein of my own knowled inther that these statements were fine or imprisonment, or both, un ay jeopardize the validity of the a	ge are true and that all statements made made with the knowledge that willful f der Section 1001 of Title 18 of the Uni oplication or any patent issued thereon	e on information and also statements and ited States Code and
POWER OF ATTORNEY: As a na application and transact all business	med inventor, I hereby appoint the in the Patent and Trademark Off	e following attorney(s) and/or agent(s) ice connected therewith (list name & r	to prosecute this
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